

# LTC1642: a Hot Swap Controller with Foldback Current Limiting and Overvoltage Protection

by Pat Madden

## Hot Circuit Insertion

When a circuit board is inserted into a “hot” (powered) backplane, its supply bypass capacitors can draw large currents from the backplane power bus as they charge. These currents can cause glitches on the backplane supply voltage, resetting other boards in the system, and can even destroy edge connectors. Like other members of Linear Technology’s Hot Swap family, the LTC1642 limits the charging current drawn by a board’s capacitors, allowing safe circuit board insertion into a hot backplane. It also offers additional capabilities, some new to the Hot Swap family: a maximum recommended operating voltage of 16.5V, a programmable electronic circuit breaker with foldback current limiting, overvoltage protection to 33V, and a voltage reference and uncommitted comparator.

In the circuit shown in Figure 1, the LTC1642 and the external NMOS pass transistor Q1 work together to

limit the charging current when a board is plugged into a hot backplane. In this application, the backplane voltage is 12V, but the chip will operate with any supply voltage between 3.0V and 16.5V. When power is first applied to V<sub>CC</sub>, the chip holds Q1’s gate at ground. After a programmable debounce delay, an internal 25µA current source begins to charge the external capacitor C2, generating a voltage ramp of 25µA/C2 V/s at the GATE pin. Because Q1 acts as a source follower while its gate ramps, the current charging the board’s bypass capacitance, C<sub>LOAD</sub>, is limited to 25µA • C<sub>LOAD</sub>/C2. An internal charge pump supplies the 25µA gate current, ensuring sufficient gate drive to Q1. Resistor R3 protects against high frequency FET oscillations; capacitor C1 sets the debounce delay, ΔT<sub>D</sub>, before the GATE pin voltage begins ramping: ΔT<sub>D</sub>(ms) = 615 • C1(µF). The ON pin is the chip’s control input; when it is below 1.22V, the

GATE pin is held at ground. If ON/OFF control of the LTC1642 is not required, ON should be tied to V<sub>CC</sub> through a 50k current limiting resistor. Typical waveforms at card insertion are shown in Figure 2.

## Short-Circuit Protection

A short circuit from Q1’s source to ground can destroy the FET; it can also reset every other card in the system if the backplane supply voltage droops due to the excessive current. The LTC1642 can protect against both threats by limiting the current drawn from the backplane supply during a short circuit and by opening an electronic circuit breaker before Q1 overheats. The addition of analog current limiting to the standard electronic circuit breaker function can improve system performance. For example, consider a system of plug-in cards powered by a backplane supply. The sudden removal of one card causes the backplane voltage to ring at a fairly high frequency, due to the step change in supply current. This ringing signal appears differentially across the sense

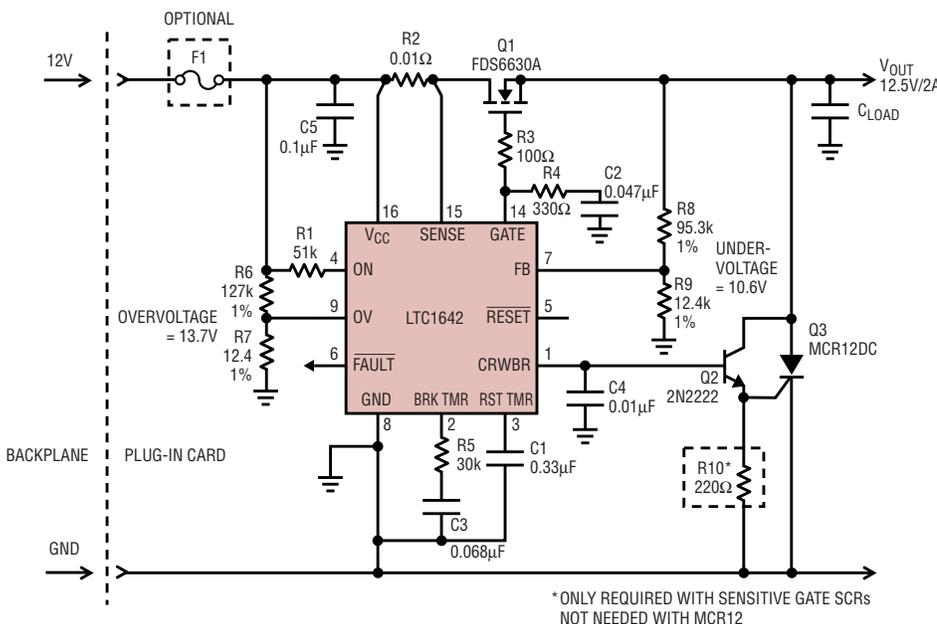


Figure 1. Typical LTC1642 Hot Swap application

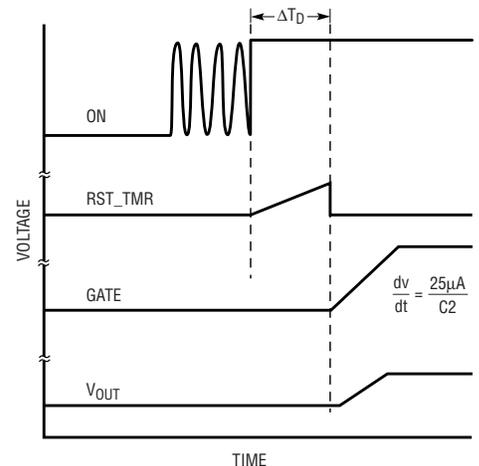
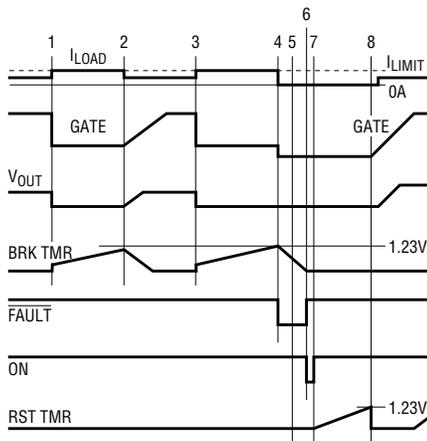


Figure 2. Typical waveforms at card insertion



**Figure 3. Current-limit and circuit-breaker timing**

resistor on each remaining card. It can trip the circuit breaker, even though there is no fault on the card. To prevent this, the designer may attempt to slow the circuit breaker by connecting a lowpass RC network across the sense resistor, only to find that one problem has been exchanged for another: if there is a short circuit on the card, the backplane voltage droops too much before the circuit breaker opens. The LTC1642 shines in this application. It regulates the load current within a few microseconds after a short circuit, before the backplane can droop, but can delay opening the circuit breaker for milliseconds or more, which allows the ringing to decay, resulting in almost complete immunity from backplane noise.

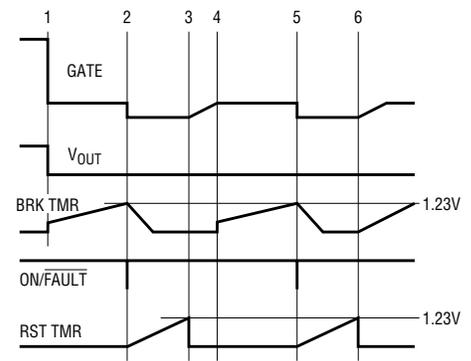
The external components that provide short-circuit protection are included in Figure 1. R2 senses the load current, and, if its voltage drop reaches the internal threshold, the current-limit servo loop adjusts the GATE pin voltage such that Q1 acts as a constant current source. R2's voltage limit decreases as the output voltage decreases; this "foldback" tends to keep Q1's power dissipation constant in current limit. The output voltage is sensed at the FB pin. When FB is grounded, the internal threshold voltage is 20mV, but this increases gradually to 50mV with increasing voltage at FB. To compensate this servo loop R4 is added in series with C2; to ensure stability, the product

$1/(2 \cdot \pi \cdot R4 \cdot C2)$  should be kept below the loop's unity-gain frequency of 125kHz and C2 should be larger than Q1's input capacitance, C<sub>ISS</sub>. The values shown in Figure 1, C2 = 0.047μF and R4 = 330Ω, work well with the Fairchild FDS6630A and similar MOSFETs. The FAULT output, when asserted, signals that the circuit breaker has opened. Capacitor C3 and resistor R5 set the delay, ΔT<sub>BRK</sub>, between the onset of current limiting and the circuit breaker opening:  $\Delta T_{BRK}(ms) = [62 - R5(k\Omega)] \cdot C3(\mu F)$ . R5 slows C3's discharge, ensuring that the circuit breaker eventually opens in the event of repetitive, but short, current faults. These are dangerous because the slow voltage ramp at Q1's gate means that it continues to dissipate substantial power for some time after the current limit clears. Larger values of R5 protect against lower duty cycle shorts, at the cost of greater uncertainty in the circuit breaker delay time. A prudent upper limit on R5 is 30k, which will open the circuit breaker if the duty cycle of a repetitive short exceeds 50%.

Typical waveforms during a short circuit are shown in Figure 3. The load is shorted to ground at time 1. The GATE voltage drops until Q1 comes into regulation and the circuit breaker timer (BRK TMR) starts. The short is cleared at time 2, before the breaker opens, and the GATE voltage ramps back up. At time 3, the load is shorted again and at time 4 the breaker opens, pulling the GATE to ground and asserting FAULT. Although the short is cleared at time 5, FAULT doesn't go high until time 6 (it has an internal 10μA pull-up), after the ON pin has been low for two microseconds. At time 7, ON goes high and the debounce timer (RST TMR) starts; at time 8 the GATE voltage begins ramping.

**Powering Up in Current Limit**

Ramping the GATE pin voltage *indirectly* limits the charging current to  $I = 25\mu A \cdot C_{LOAD}/C2$ , where C2 is the external capacitor connected to the GATE and C<sub>LOAD</sub> is the load capaci-



**Figure 4. Automatic restart following a short circuit**

tance. If the value of C<sub>LOAD</sub> is uncertain, a worst-case design can result in needlessly long ramp times and it may be better to limit the charging current *directly* by allowing the LTC1642 to power up in current limit. This is perfectly acceptable as long as the circuit breaker delay is long enough to power up under worst-case conditions.

**Automatically Restarting after the Circuit Breaker Opens**

The LTC1642 will automatically attempt to restart itself after the circuit breaker opens if the FAULT output is tied to the ON pin input. The resulting waveforms during a short circuit are shown in Figure 4. As the figure shows, pass transistor Q1's duty cycle is equal to the circuit breaker delay, ΔT<sub>BRK</sub>, divided by the sum of the circuit breaker and debounce delays, ΔT<sub>BRK</sub> + ΔT<sub>D</sub>. Q1 dissipates substantial power while acting as a constant current source, so be sure its maximum junction temperature is not exceeded in worst-case conditions. For example, the FDS6630A in Figure 1 dissipates 24W(= 2A • 12V) DC when the load is shorted to ground. Its absolute maximum junction temperature, T<sub>J</sub>, is 150°C, so an ambient temperature, T<sub>A</sub>, of 85°C requires an effective junction-to-ambient thermal resistance of 2.7°C/W (= (T<sub>J</sub> - T<sub>A</sub>)/(I • V)) or less. The effective junction-to-ambient thermal resistance is the product of two factors: θ<sub>JA</sub>, the DC junction-to-ambient thermal resistance, which depends on the package and board layout; and r(t), a

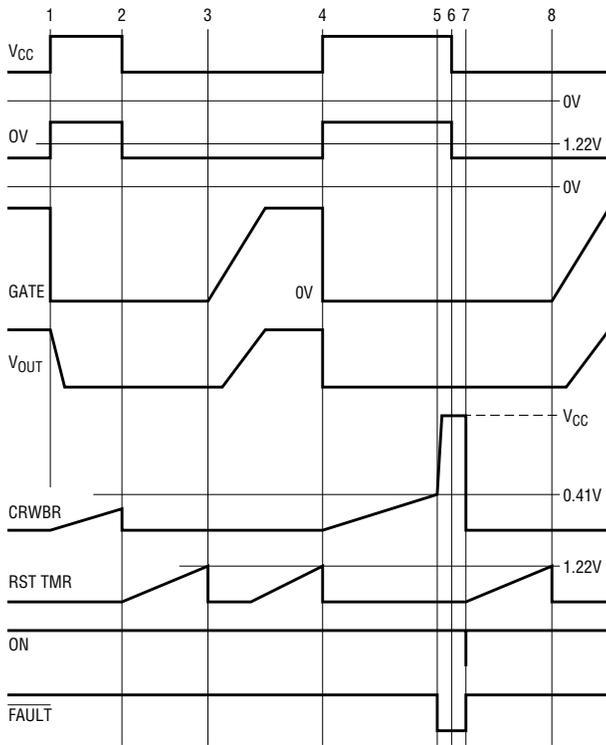


Figure 5. Overvoltage timing

derating factor that depends on the transistor's duty cycle and "on" time. Referring to the FDS6630A's data sheet, a 0.2in<sup>2</sup> mounting pad of 2oz. copper on an FR-4 board produces a DC thermal resistance,  $\theta_{JA}$ , of 105°C/W; referring to Figure A (Transient Thermal Response Curve—reproduced from the FDS6630A data sheet), a 2ms circuit breaker delay and a 200ms debounce delay produce an  $r(t)$  derating of 0.02; the overall effective thermal resistance is 2.1°C/W ( $= r(t) \cdot \theta_{JA}$ ).

If FAULT is tied to ON, open-drain logic should be used to drive the node, and the external pull up resis-

tor at the ON pin may be omitted, because FAULT provides a weak internal pull-up.

### Overvoltage Protection

The LTC1642 can protect a card from excessive voltage by quickly turning off the pass transistor if the supply voltage exceeds a programmable limit and by triggering a crowbar SCR after a programmable delay. The LTC1642 includes an internal regulator that protects against supply voltages up to 33V. It can also be configured to automatically restart when an overvoltage condition clears.

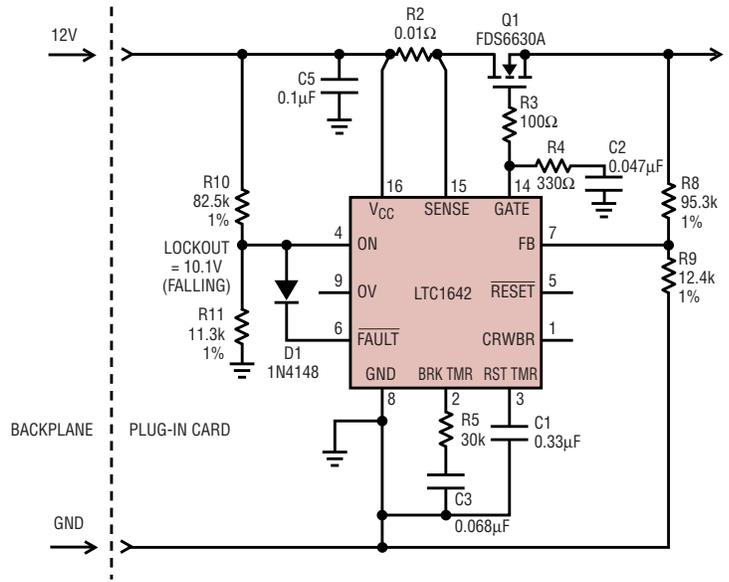


Figure 6. Increasing the undervoltage lockout threshold

The external components that provide overvoltage protection are included in Figure 1. Resistors R6 and R7 set the overvoltage limit, timing capacitor C4 sets the delay before the crowbar SCR Q3 fires and NPN follower Q2 boosts the trigger current into Q3. When V<sub>CC</sub> exceeds  $(1 + R6/R7) \cdot 1.22V$ , an internal comparator trips and the chip cuts off Q1 by pulling its gate to ground. For better noise rejection, the propagation delay through the comparator (on a low-to-high transition at OV) increases from 20μs to 80μs as the differential input voltage decreases from 175mV to 3mV. Once the comparator trips, an internal 45μA current starts charging C4; when it reaches 0.41V the current increases to 1.5mA and Q2 quickly triggers the SCR. The delay,  $\Delta T_{SCR}$ , before the SCR triggers is  $\Delta T_{SCR}(ms) =$

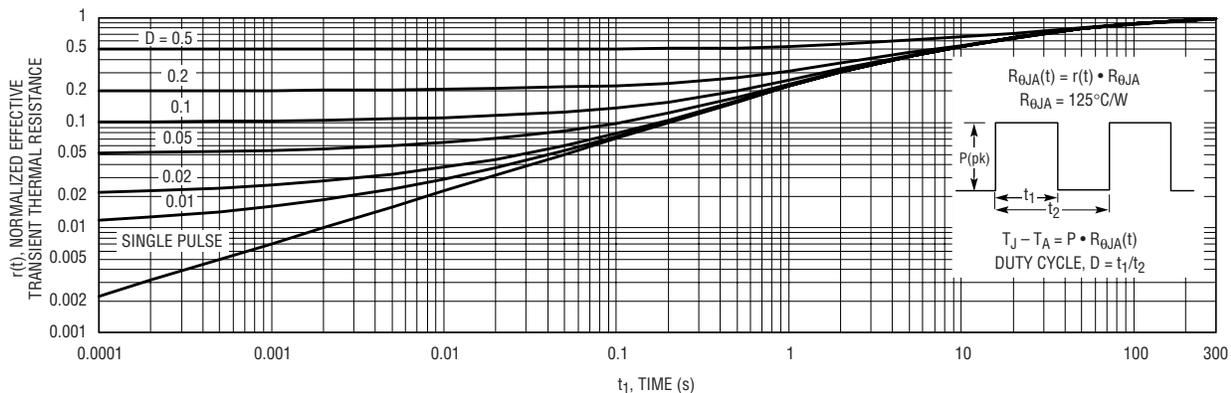


Figure A. Fairchild FDS6630A transient thermal response curve (reproduced by permission, from the FDS6630A data sheet)

9 • C4(μF). Once C4 reaches 0.41V, the LTC1642 latches off. After the overvoltage clears, GATE and FAULT remain at ground and the 1.5mA charging current persists. To restart after the overvoltage clears, hold the ON pin low for at least 2μs and then bring it high. The GATE voltage will begin ramping up after a debounce delay. The chip will restart if FAULT and ON are connected together: the GATE voltage begins ramping up one debounce delay after the overvoltage clears.

Figure 5 shows typical waveforms. The OV comparator goes high at time 1, causing the chip to pull the GATE pin to ground and start charging C4. At time 2, before the capacitor reaches 0.41V, OV falls below 1.22V; C4 discharges and the GATE voltage begins ramping after the debounce delay ends at time 3. Another overvoltage begins at time 4, and at time 5 C4 reaches 0.41V; FAULT goes low and the charging current increases to 1.5mA. Even after OV falls below 1.22V at time 6, GATE and FAULT stay low and CRWBR continues to source 1.5mA. FAULT goes high when ON goes low momentarily at time 7; after a debounce delay ending at time 8, the GATE voltage begins ramping.

The LTC1642's internal regulator turns on when V<sub>CC</sub> exceeds 17.5V and turns off when it drops below 17.0V. While on, it limits the internal supply voltage to most of the chip's circuits to 15V. They will function normally except that the GATE pin charge pump is disabled. Set the resistor divider at the OV pin to ensure that GATE is grounded with V<sub>CC</sub> levels above 16.5V.

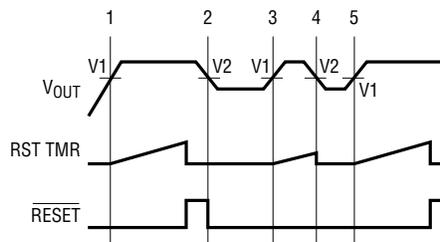


Figure 7. Undervoltage monitor waveforms

## Undervoltage Lockout

An internal undervoltage lockout circuit keeps the GATE pin at ground until V<sub>CC</sub> exceeds 2.73V. If it falls below 2.5V, the lockout circuit pulls GATE to ground and resets the circuit breaker and SCR trigger. To set a higher lockout voltage, tie the ON pin to a resistor divider driven from V<sub>CC</sub>, as shown in Figure 6. The chip remains locked out until V<sub>CC</sub> exceeds  $(1 + R10/R11) \cdot 1.33V$  and will also lock out if V<sub>CC</sub> falls below  $(1 + R10/R11) \cdot 1.22V$ . If the resistive divider is used in conjunction with automatic restart, connect FAULT to ON through a diode, as shown. Otherwise FAULT's internal pull-up current, which varies with operating voltage and temperature, will skew the lockout threshold.

## Undervoltage Monitor

In Figure 1, the LTC1642's FB pin monitors the output voltage; the chip asserts RESET if the output falls below  $1.22V \cdot (1 + R8/R9)$  (10.6V for the R8 and R9 values in the figure). RESET goes high (it has a 10μA internal pull-up) when the output has continuously exceeded this voltage for one debounce delay. Typical waveforms are shown in Figure 7. On power-up, RESET is

asserted; it remains low until one debounce delay ( $\Delta T_D(ms) = 615 \cdot C1(\mu F)$ ) after FB crosses 1.22V at time 1. At time 2, FB falls below 1.22V and RESET is asserted immediately. When FB exceeds its threshold at time 3, the debounce timer starts, but FB falls below 1.22V (time 4) before the debounce delay ends and RESET remains low. FB crosses 1.22V once more at time 5 and RESET goes high one debounce delay later. To improve noise rejection, the FB comparator's propagation delay (on a falling edge at FB) increases from 20μs to 80μs as the differential input voltage decreases from 175mV to 3mV.

## Reference and Uncommitted Comparator

The LTC1642's internal voltage reference is buffered and brought out to the REF pin. The buffer amplifier should be compensated with a capacitor connected between REF and ground. If no DC current is drawn from REF, 0.1μF ensures an adequate phase margin, but larger capacitors can be used for better suppression of high frequency noise on REF.

The LTC1642 also includes an uncommitted comparator with an open drain output and a common mode input range includes ground.

## Conclusion

The LTC1642 is a rugged Hot Swap controller that can handle positive supplies up to 15V. It also provides fast, effective current limiting even in the presence of a noisy backplane supply and can protect plug-in cards against overvoltages up to 33V. 



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